



# Vincotech

<b>flowANPC 2</b>	<b>950 V / 200 A</b>
<b>Topology features</b> <ul style="list-style-type: none"><li>• Temperature sensor</li><li>• Advanced Neutral Point Clamped topology</li></ul>	<b>flow 2 13 mm housing</b> 
<b>Component features</b> <ul style="list-style-type: none"><li>• Low collector emitter saturation voltage</li><li>• High speed and smooth switching</li></ul>	
<b>Housing features</b> <ul style="list-style-type: none"><li>• Base isolation: Al<sub>2</sub>O<sub>3</sub></li><li>• Convex shaped baseplate for superior thermal contact</li><li>• Cu baseplate</li><li>• Thermo-mechanical push-and-pull force relief</li><li>• Press-fit pin</li><li>• Reliable cold welding connection</li></ul>	
<b>Target applications</b> <ul style="list-style-type: none"><li>• Energy Storage Systems</li><li>• Solar Inverters</li></ul>	<b>Schematic</b> 
<b>Types</b> <ul style="list-style-type: none"><li>• 30-PT10NAA200S701-PE59F08Y</li></ul>	



30-PT10NAA200S701-PE59F08Y

datasheet

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## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>AC Switch</b>				
Collector-emitter voltage	$V_{CES}$		950	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	203	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	256	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## AC Diode

Peak repetitive reverse voltage	$V_{RRM}$		950	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	108	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	192	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Neutral Point Switch

Collector-emitter voltage	$V_{CES}$		950	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	153	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	300	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$



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## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>DC-Link Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		950	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$	108	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	192	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## DC-Link Switch

Collector-emitter voltage	$V_{CES}$		950	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$	153	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	300	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Neutral Point Diode

Peak repetitive reverse voltage	$V_{RRM}$		950	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$	108	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	192	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Capacitor (DC)

Maximum DC voltage	$V_{MAX}$		750	V
		$T_j = 125^\circ\text{C}$	1000	
		$T_j = 150^\circ\text{C}$	750	
Operation Temperature	$T_{op}$		-55 ... 150	$^\circ\text{C}$



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## Maximum Ratings

$T_j = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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### Module Properties

Thermal Properties				
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Storage temperature	$T_{stg}$		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	$^\circ\text{C}$

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Creepage distance				>12,7	mm
Clearance				>12,7	mm
Comparative Tracking Index	CTI			$\geq 600$	

\*100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### AC Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00325	25	4,15	4,85	5,65	V	
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		200	25 125 150		1,22 1,25 1,26	1,4 <sup>(1)</sup>	V	
Collector-emitter cut-off current	$I_{CES}$		0	950		25			4	μA	
Gate-emitter leakage current	$I_{GES}$		20	0		25			100	nA	
Internal gate resistance	$r_g$							1,5		Ω	
Input capacitance	$C_{res}$	$f = 100$ kHz	0	25	25	25	24600	265	110	pF	
Output capacitance	$C_{oes}$										
Reverse transfer capacitance	$C_{res}$										
Gate charge	$Q_g$		±15		0	25		2050		nC	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,37		K/W	
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### AC Diode

#### Static

Forward voltage	$V_F$				200	25 125 150	2,1	2,64 2,44 2,36	2,8 <sup>(1)</sup>	V	
Reverse leakage current	$I_R$	$V_r = 950$ V				25			8	μA	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,5		K/W	
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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Neutral Point Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00334	25	4,35	5,1	5,85	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		200	25 125 150		1,83 2,06 2,11	2,35 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	950		25			4	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25			200	nA
Internal gate resistance	$r_g$							0,75		Ω
Input capacitance	$C_{res}$	$f = 100$ kHz	0	25	25	25	13000		pF	
Output capacitance	$C_{oes}$									
Reverse transfer capacitance	$C_{res}$									
Gate charge	$Q_g$		±15		0	25		460		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,32		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$	$\pm 15$	750	170	25		85,83		
Rise time	$t_r$					125		88,21		ns
						150		89,19		
Turn-off delay time	$t_{d(off)}$					25		13,34		
						125		15,07		
Fall time	$t_f$					150		15,31		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD}=4,95 \mu C$ $Q_{tFWD}=11,2 \mu C$ $Q_{tFWD}=13,4 \mu C$	$\pm 15$	750	170	25		101,78		
						125		131,72		
						150		139,97		
Turn-off energy (per pulse)	$E_{off}$					25		19,65		
						125		41,02		
						150		50,59		ns
						25		7,2		
						125		9,86		
						150		10,58		mWs
						25		5,22		
						125		9,58		
						150		10,81		mWs



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### DC-Link Diode

#### Static

Forward voltage	$V_F$				200	25 125 150	2,1	2,64 2,44 2,36	2,8 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 950$ V			25			8	$\mu$ A	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,5		K/W
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#### Dynamic

Peak recovery current	$I_{RM}$	$di/dt=6941$ A/ $\mu$ s $di/dt=7416$ A/ $\mu$ s $di/dt=7571$ A/ $\mu$ s	$\pm 15$	750	170	25		104,12		
Reverse recovery time	$t_{rr}$					125		156,48		
Recovered charge	$Q_r$					150		171,85		
Reverse recovered energy	$E_{rec}$		25			110,17				ns
Reverse recovered energy	$E_{rec}$		125			150,99				
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		150			166,05				
			25			4,95				$\mu$ C
			125			11,2				
			150			13,4				
			25			1,88				mWs
			125			4,69				
			150			5,74				
			25			2387,68				
			125			1344,81				
			150			1455,48				
										A/ $\mu$ s



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### DC-Link Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00334	25	4,35	5,1	5,85	V	
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		200	25 125 150		1,83 2,06 2,11	2,35 <sup>(1)</sup>	V	
Collector-emitter cut-off current	$I_{CES}$		0	950		25			4	μA	
Gate-emitter leakage current	$I_{GES}$		20	0		25			200	nA	
Internal gate resistance	$r_g$							0,75		Ω	
Input capacitance	$C_{res}$	$f = 100 \text{ kHz}$	0	25	25	25	13000		pF		
Output capacitance	$C_{oes}$										
Reverse transfer capacitance	$C_{res}$										
Gate charge	$Q_g$		±15		0	25		460		nC	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,32		K/W	
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	$\pm 15$	750	170	25		260,37			ns
Rise time	$t_r$					125		258,01			
						150		257,36			
Turn-off delay time	$t_{d(off)}$					25		38,04			
						125		40,64			
Fall time	$t_f$					150		41,29			
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD}=4,32 \mu\text{C}$ $Q_{fFWD}=10,47 \mu\text{C}$ $Q_{ffwd}=12,58 \mu\text{C}$				25		189,81			
						125		221,15			
Turn-off energy (per pulse)	$E_{off}$					150		229,97			
						25		20,63			
						125		41,58			
						150		49,96			
						25		12,71			
						125		15,81			mWs
						150		16,54			
						25		5,16			
						125		8,57			
						150		9,48			mWs



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Neutral Point Diode

#### Static

Forward voltage	$V_F$				200	25 125 150	2,1	2,64 2,44 2,36	2,8 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 950$ V			25			8	$\mu$ A	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,5		K/W
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#### Dynamic

Peak recovery current	$I_{RM}$	$di/dt=3481$ A/ $\mu$ s $di/dt=3450$ A/ $\mu$ s $di/dt=3656$ A/ $\mu$ s	$\pm 15$	750	170	25		81,59		
Reverse recovery time	$t_{rr}$					125		123,07		
Recovered charge	$Q_r$					150		133,99		
Reverse recovered energy	$E_{rec}$		25			125		127,76		
Reverse recovered energy	$E_{rec}$		125			150		182,08		ns
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		150			25		197,89		
			25			125		4,32		$\mu$ C
			125			150		10,47		
			150			25		12,58		
			25			125		1,35		mWs
			125			150		3,66		
			150			25		4,58		
			25			125		1504,45		
			125			150		1171,27		A/ $\mu$ s
			150			25		1258,98		



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Capacitor (DC)

#### Static

Capacitance	$C$	DC bias voltage = 0 V				25		750		V
Tolerance							-5		5	%
Dissipation factor		$f = 1$ kHz				25		0,1		%

### Thermistor

#### Static

Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5	5		%
Power dissipation	$P$					25		130		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference								I		

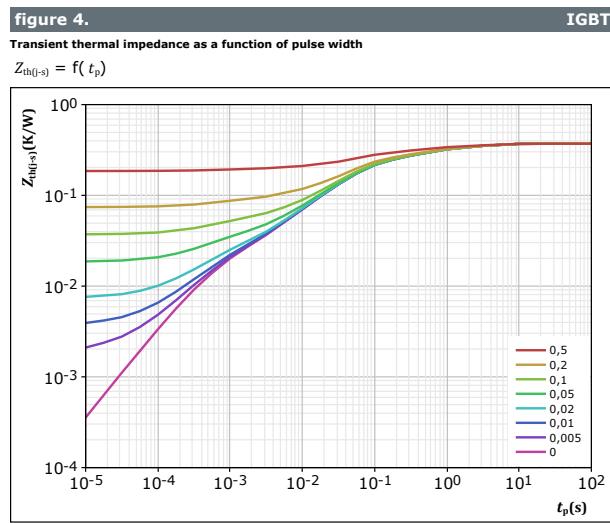
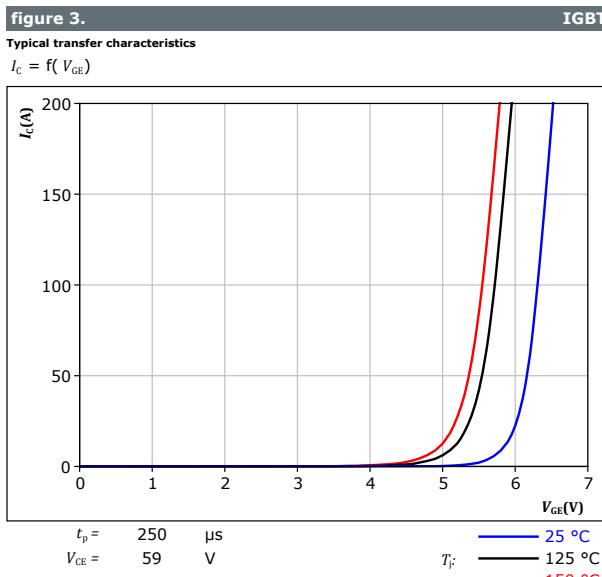
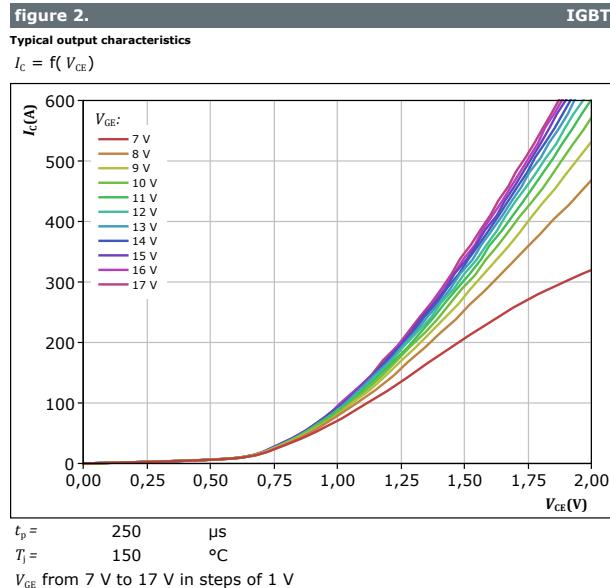
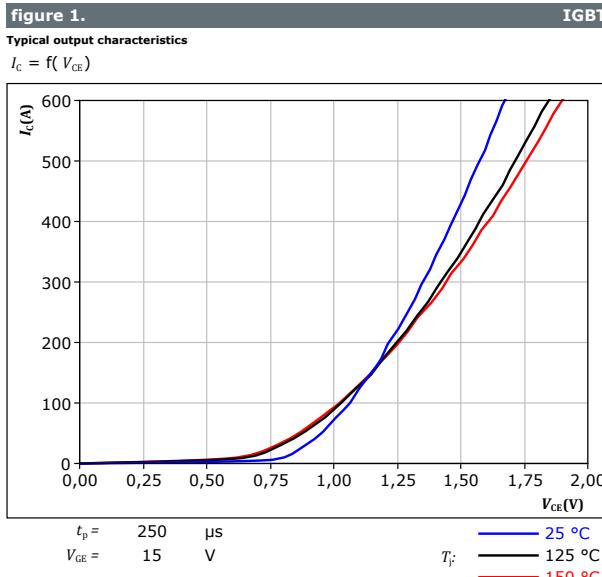
<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.



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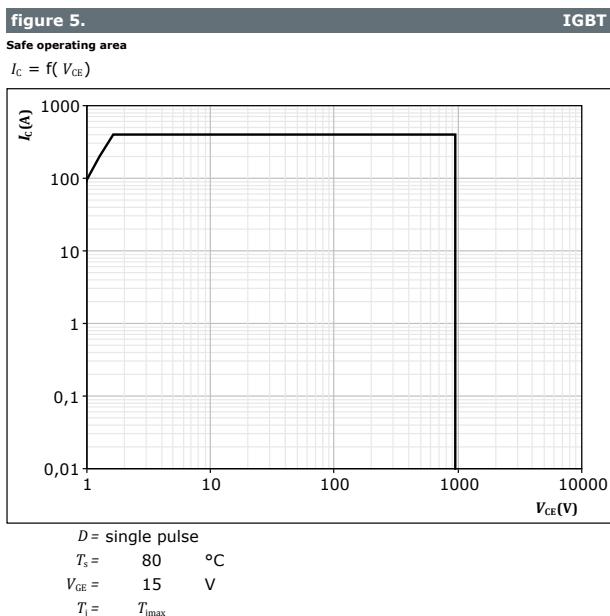
## AC Switch Characteristics



IGBT thermal model values		
$R$ (K/W)	$\tau$ (s)	
6,29E-02	2,66E+00	
9,87E-02	3,54E-01	
1,71E-01	4,59E-02	
2,32E-02	6,22E-03	
1,51E-02	5,38E-04	



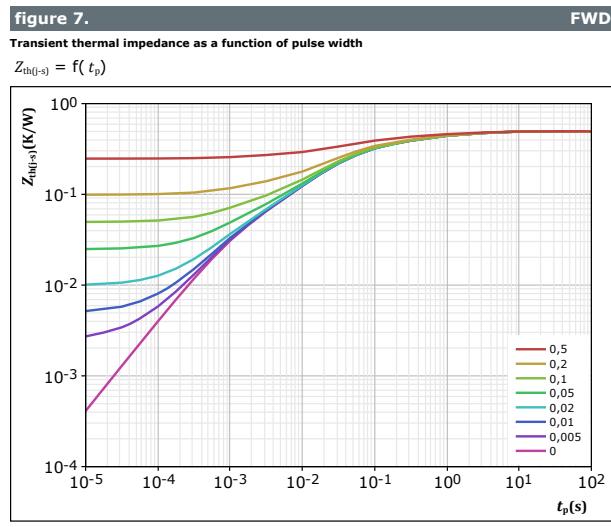
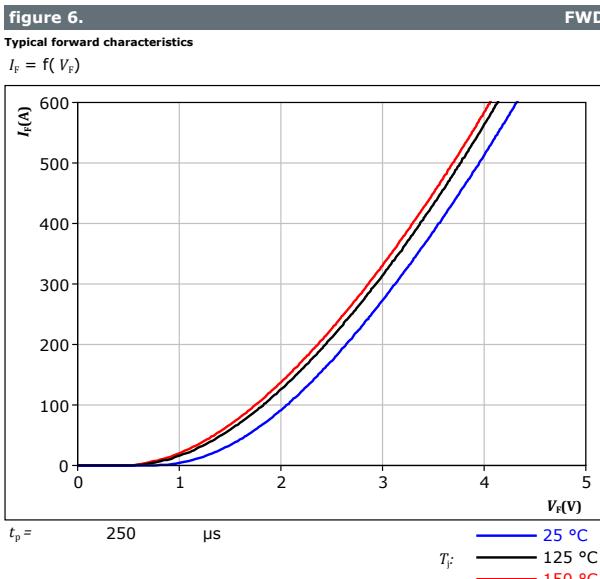
## AC Switch Characteristics





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## AC Diode Characteristics



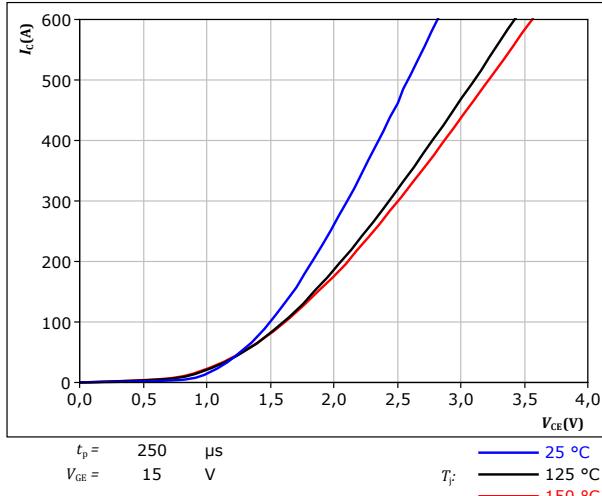


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## Neutral Point Switch Characteristics

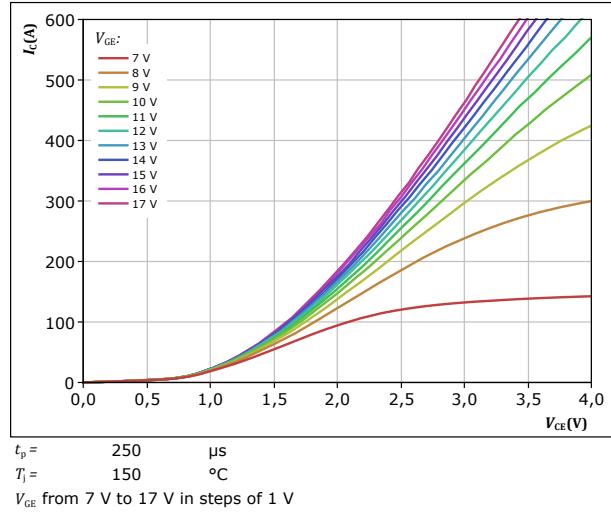
**figure 8.** IGBT

Typical output characteristics  
 $I_C = f(V_{CE})$



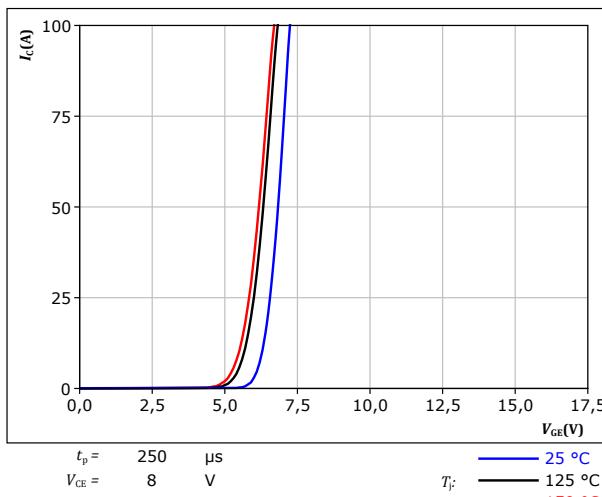
**figure 9.** IGBT

Typical output characteristics  
 $I_C = f(V_{CE})$



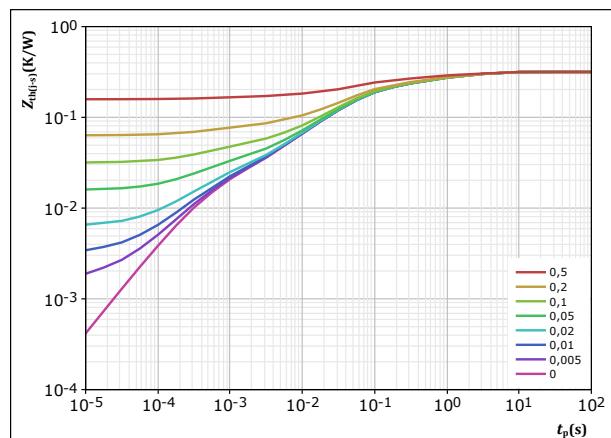
**figure 10.** IGBT

Typical transfer characteristics  
 $I_C = f(V_{GE})$



**figure 11.** IGBT

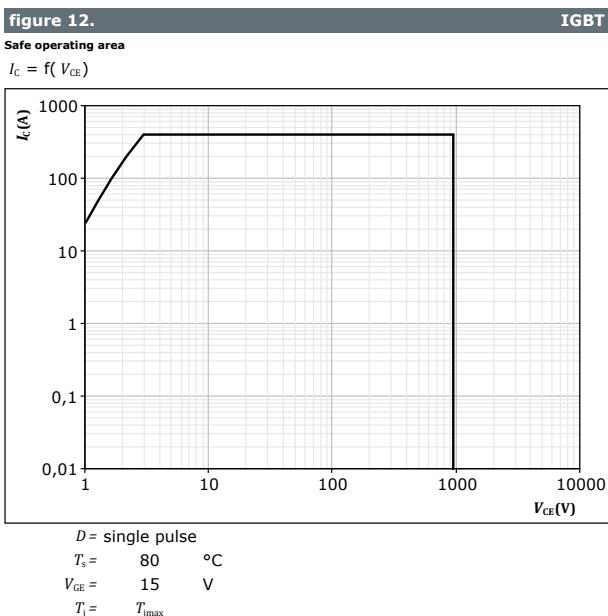
Transient thermal impedance as a function of pulse width  
 $Z_{th(j-s)} = f(t_p)$



$D =$	$t_p / T$	$R$ (K/W)	$\tau$ (s)
		$6,47E-02$	$2,21E+00$
		$8,02E-02$	$2,58E-01$
		$1,36E-01$	$3,99E-02$
		$2,02E-02$	$4,97E-03$
		$1,51E-02$	$4,41E-04$



## Neutral Point Switch Characteristics





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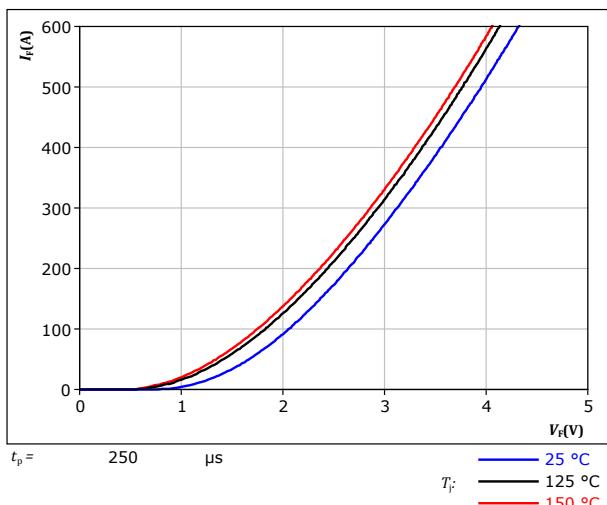
## DC-Link Diode Characteristics

figure 13.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

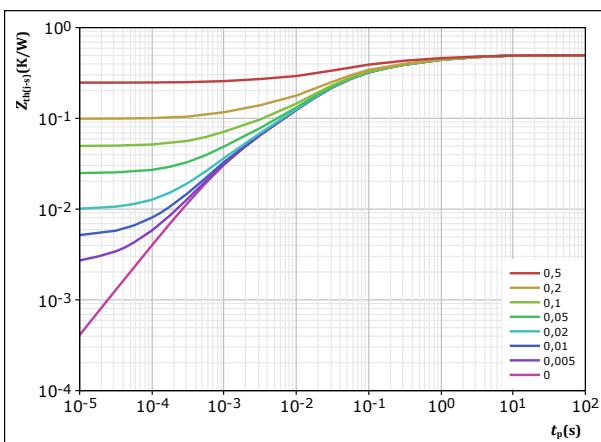
$T_F$ : 25 °C  
125 °C  
150 °C

figure 14.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,495 \text{ K/W}$$

FWD thermal model values

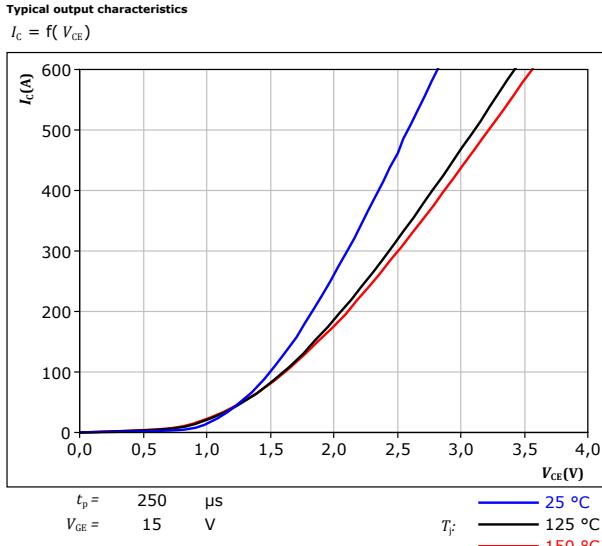
$R$ (K/W)	$\tau$ (s)
5,54E-02	3,24E+00
1,07E-01	4,54E-01
1,95E-01	5,74E-02
1,05E-01	1,25E-02
3,26E-02	1,12E-03



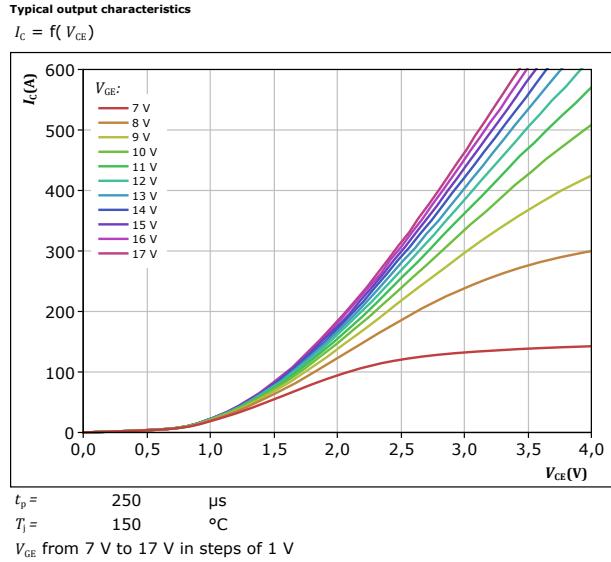
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## DC-Link Switch Characteristics

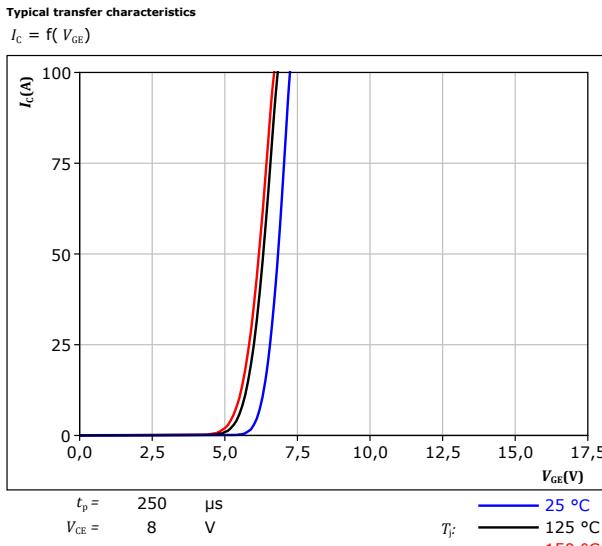
**figure 15.** IGBT



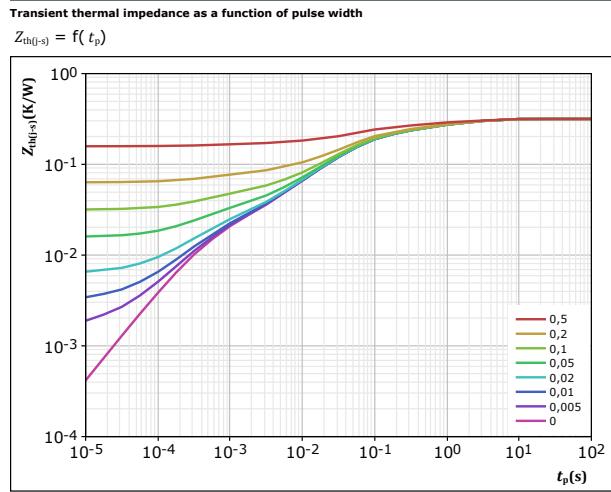
**figure 16.** IGBT



**figure 17.** IGBT



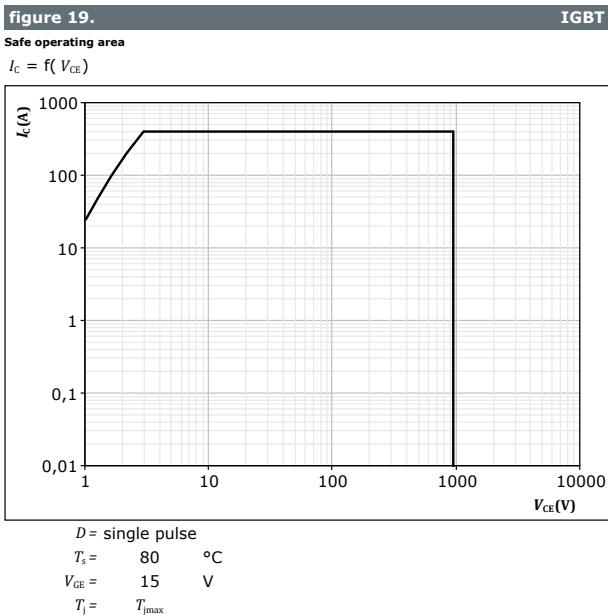
**figure 18.** IGBT



$R_{th(j-s)}$	$t_p / T$	$\tau$ (s)
6,47E-02	0,316	K/W
8,02E-02		
1,36E-01		
2,02E-02		
1,51E-02		
		IGBT thermal model values
$R$ (K/W)		
6,47E-02		2,21E+00
8,02E-02		2,58E-01
1,36E-01		3,99E-02
2,02E-02		4,97E-03
1,51E-02		4,41E-04



## DC-Link Switch Characteristics





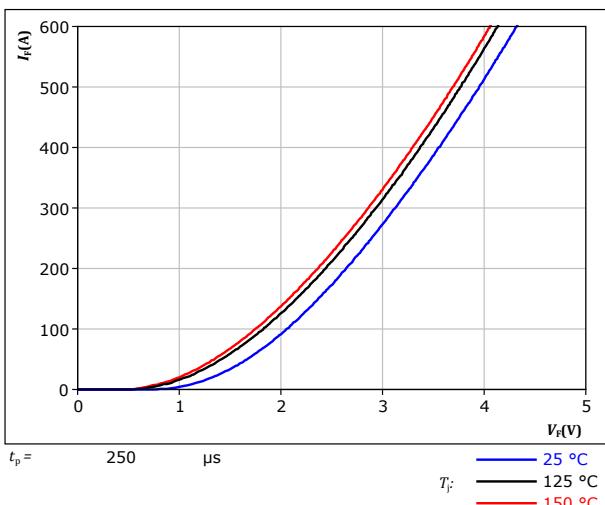
## Neutral Point Diode Characteristics

**figure 20.**

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

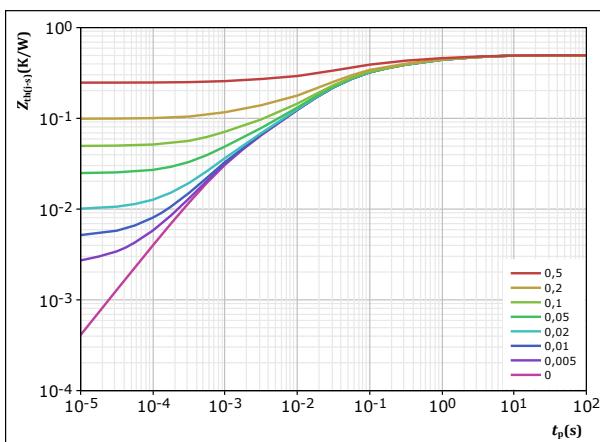
$T_F$ :  
— 25 °C  
— 125 °C  
— 150 °C

**figure 21.**

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T}$$

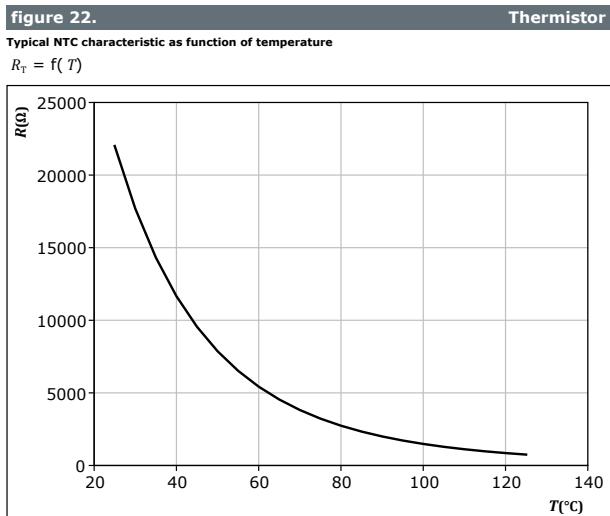
$$R_{th(j-s)} = 0,495 \text{ K/W}$$

FWD thermal model values

$R$ (K/W)	$\tau$ (s)
5,54E-02	3,24E+00
1,07E-01	4,54E-01
1,95E-01	5,74E-02
1,05E-01	1,25E-02
3,26E-02	1,12E-03



## Thermistor Characteristics



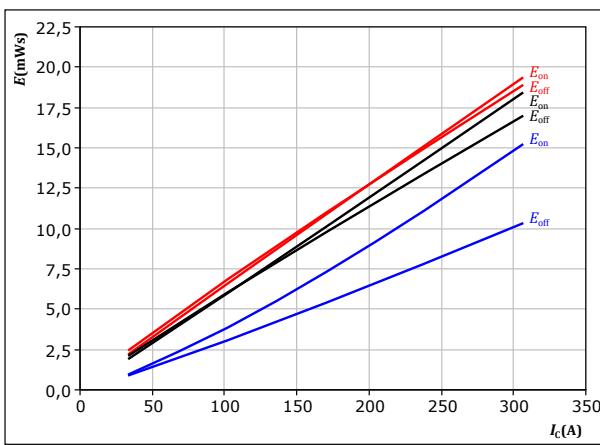


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## Neutral Point Switching Characteristics

figure 23. IGBT

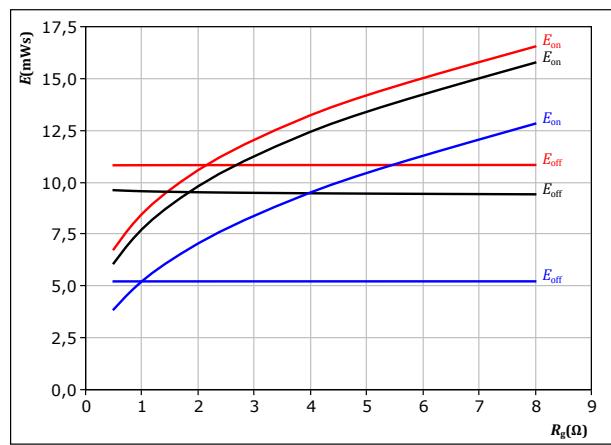
Typical switching energy losses as a function of collector current  
 $E = f(I_c)$



With an inductive load at  
 $V_{CE} = 750$  V       $T_j:$  25 °C  
 $V_{GE} = \pm 15$  V      125 °C  
 $R_{gon} = 2$  Ω      150 °C  
 $R_{goff} = 2$  Ω

figure 24. IGBT

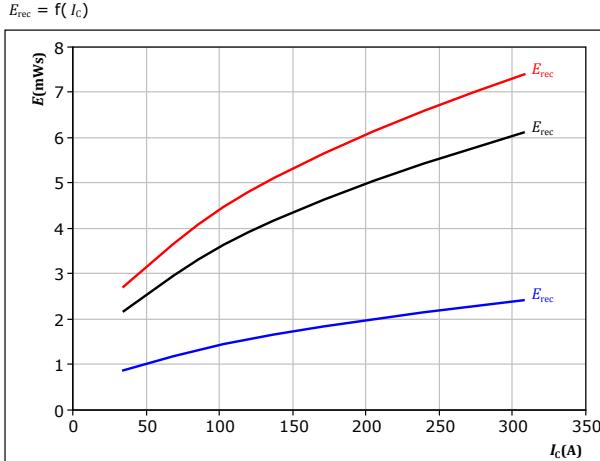
Typical switching energy losses as a function of IGBT turn on gate resistor  
 $E = f(R_g)$



With an inductive load at  
 $V_{CE} = 750$  V       $T_j:$  25 °C  
 $V_{GE} = \pm 15$  V      125 °C  
 $I_c = 170$  A      150 °C

figure 25. FWD

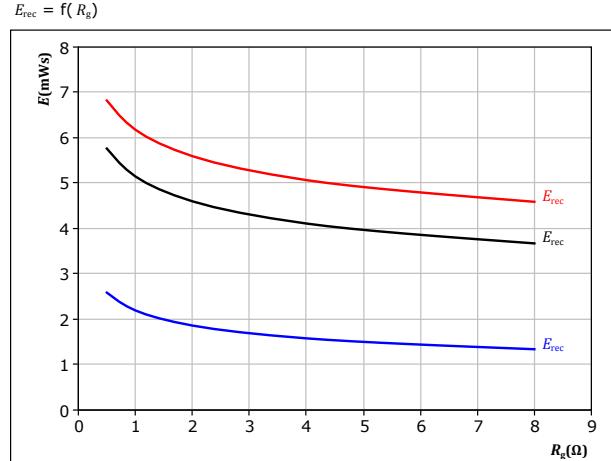
Typical reverse recovered energy loss as a function of collector current  
 $E_{rec} = f(I_c)$



With an inductive load at  
 $V_{CE} = 750$  V       $T_j:$  25 °C  
 $V_{GE} = \pm 15$  V      125 °C  
 $R_{gon} = 2$  Ω      150 °C

figure 26. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at  
 $V_{CE} = 750$  V       $T_j:$  25 °C  
 $V_{GE} = \pm 15$  V      125 °C  
 $I_c = 170$  A      150 °C

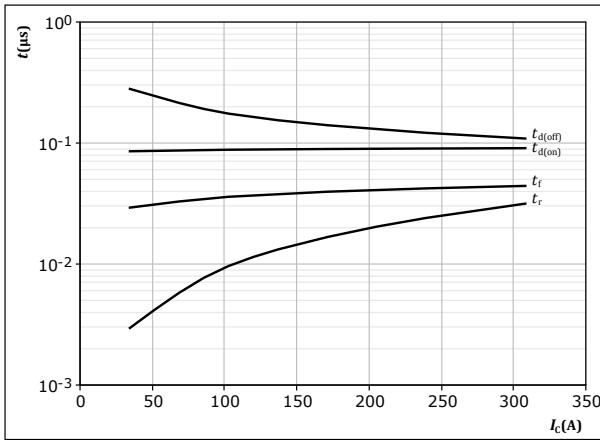


Vincotech

## Neutral Point Switching Characteristics

figure 27. IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$

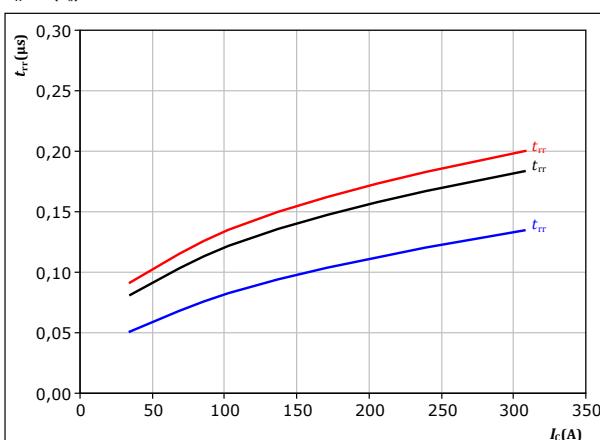


With an inductive load at

$T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 750 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \Omega$   
 $R_{goff} = 2 \Omega$

figure 29. FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$

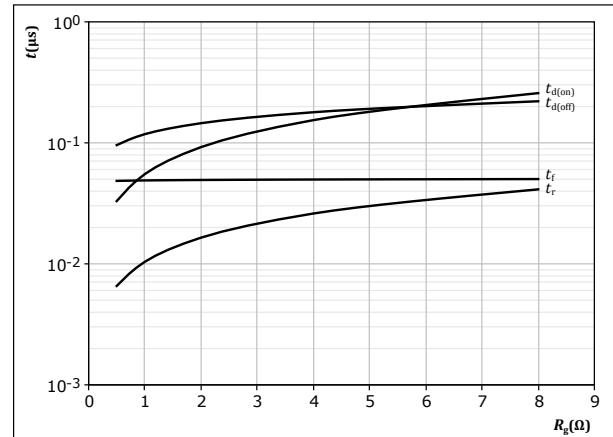


With an inductive load at

$V_{CE} = 750 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \Omega$

figure 28. IGBT

Typical switching times as a function of IGBT turn on gate resistor  
 $t = f(R_g)$

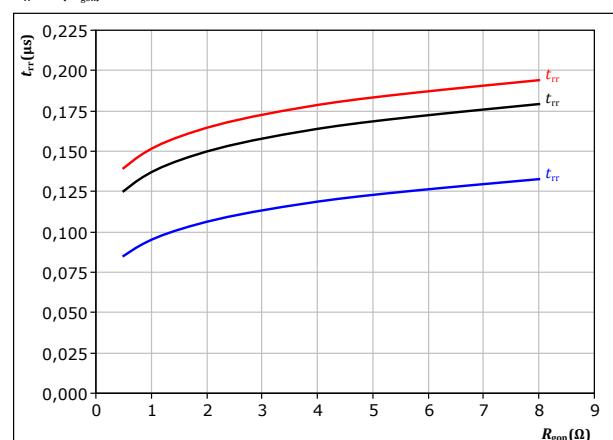


With an inductive load at

$T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 750 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 170 \text{ A}$

figure 30. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 750 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 170 \text{ A}$



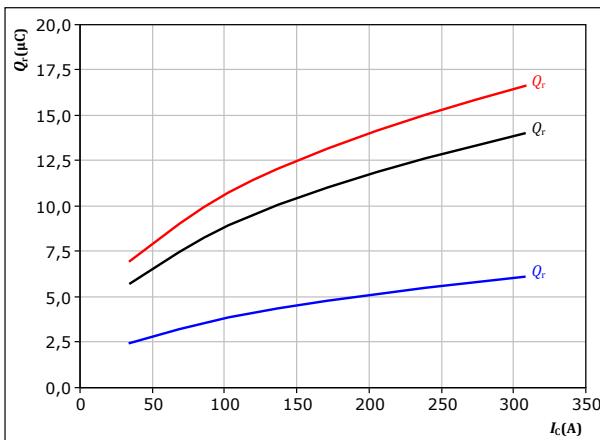
Vincotech

## Neutral Point Switching Characteristics

figure 31.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

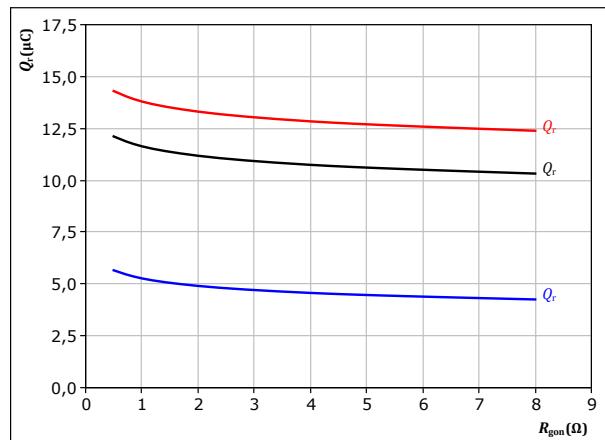
$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 2 \Omega & & \end{aligned}$$

FWD

figure 32.

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

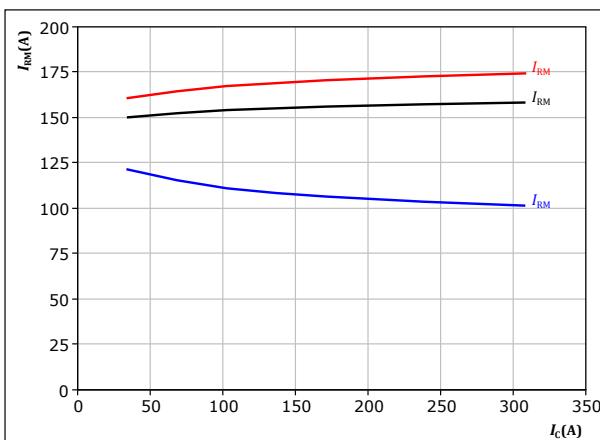
$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 170 \text{ A} & & \end{aligned}$$

FWD

figure 33.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

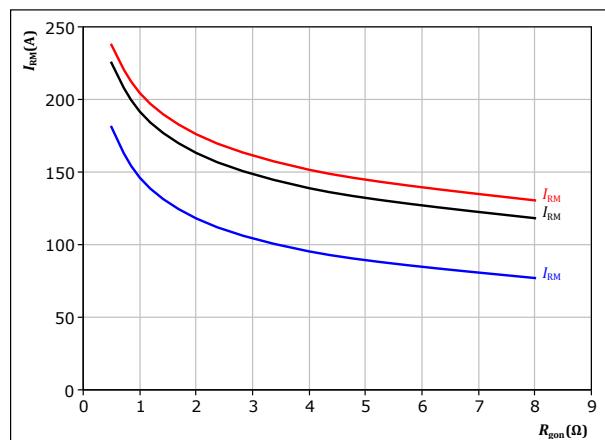
$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 2 \Omega & & \end{aligned}$$

FWD

figure 34.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 170 \text{ A} & & \end{aligned}$$

FWD

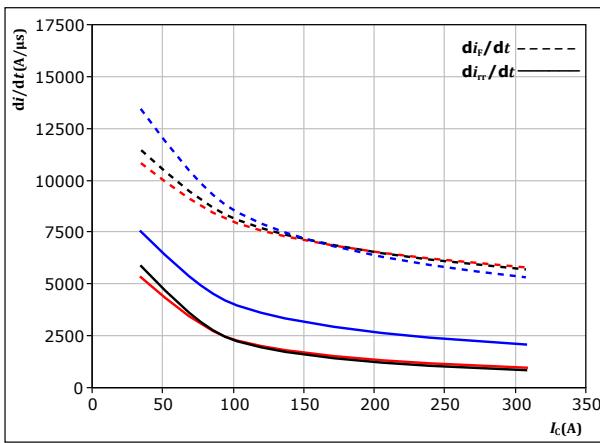


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## Neutral Point Switching Characteristics

figure 35. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_c)$

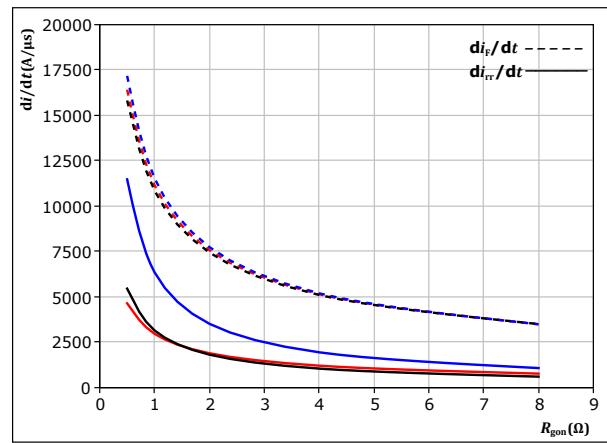


With an inductive load at

$V_{CE} = 750 \text{ V}$        $T_j = 25^\circ\text{C}$   
 $V_{GE} = \pm 15 \text{ V}$        $T_j = 125^\circ\text{C}$   
 $R_{gon} = 2 \Omega$        $T_j = 150^\circ\text{C}$

figure 36. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



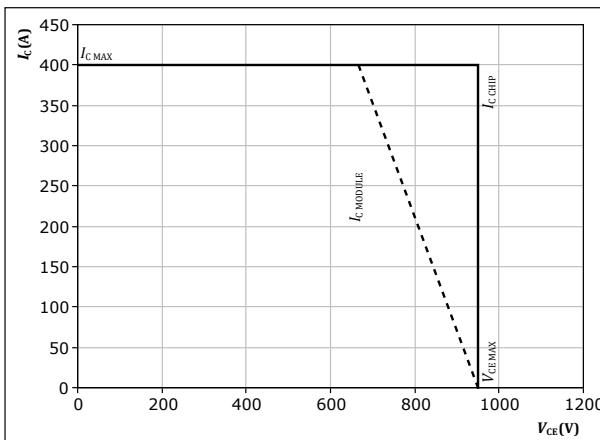
With an inductive load at

$V_{CE} = 750 \text{ V}$        $T_j = 25^\circ\text{C}$   
 $V_{GE} = \pm 15 \text{ V}$        $T_j = 125^\circ\text{C}$   
 $I_c = 170 \text{ A}$        $T_j = 150^\circ\text{C}$

figure 37. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At       $T_j = 150^\circ\text{C}$   
 $R_{gon} = 2 \Omega$   
 $R_{goff} = 2 \Omega$



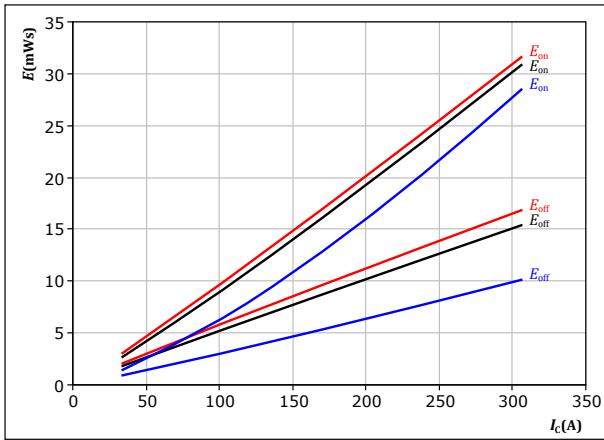
Vincotech

## DC-Link Switching Characteristics

figure 38.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

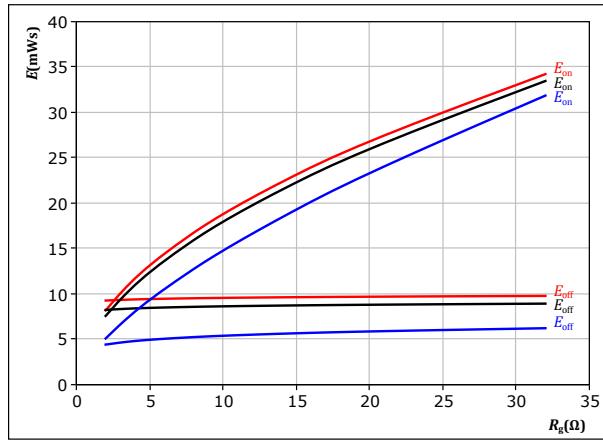
$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 125 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 8 \Omega & & \\ R_{goff} &= 8 \Omega & & \end{aligned}$$

IGBT

figure 39.

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

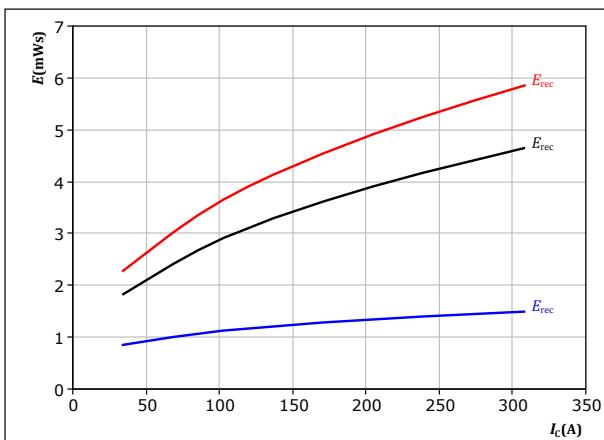
$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 125 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 170 \text{ A} & & \end{aligned}$$

IGBT

figure 40.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

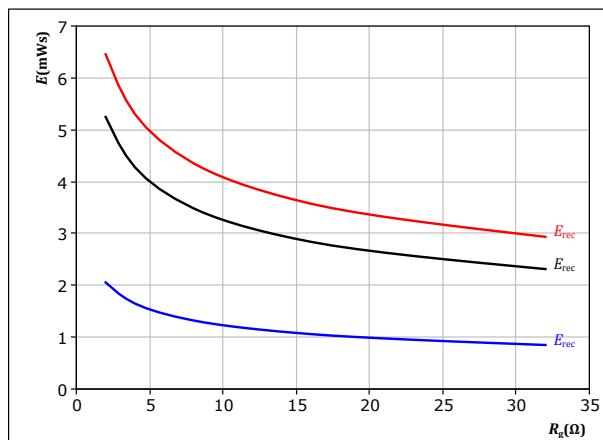
$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 125 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 8 \Omega & & \end{aligned}$$

FWD

figure 41.

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 125 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 170 \text{ A} & & \end{aligned}$$

FWD



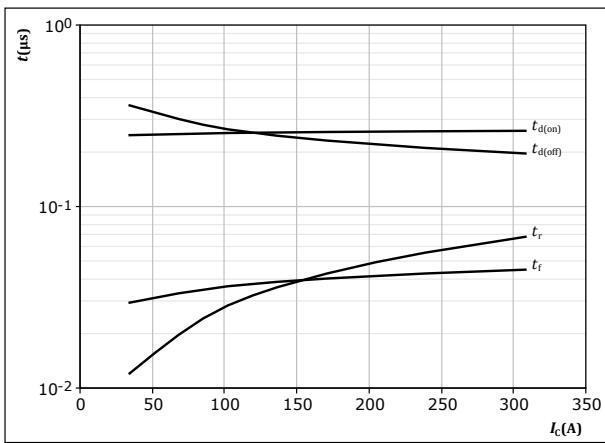
Vincotech

## DC-Link Switching Characteristics

figure 42.

IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$



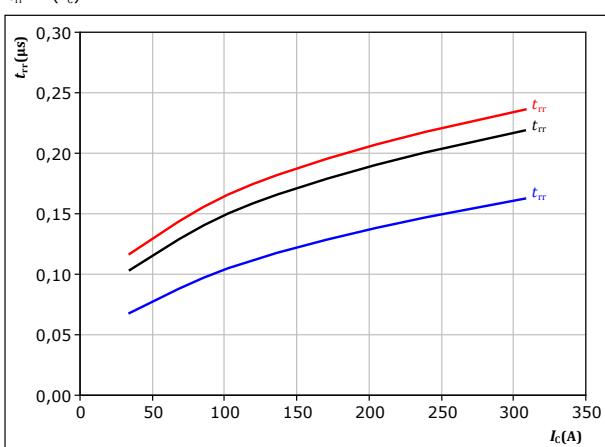
With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 750 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 8 \Omega$   
 $R_{goff} = 8 \Omega$

figure 44.

FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$



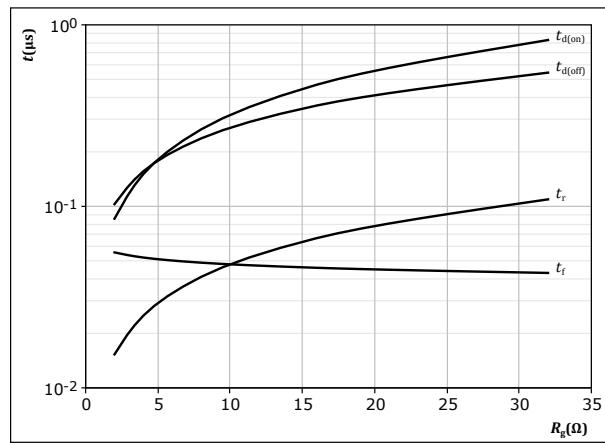
With an inductive load at

$V_{CE} = 750 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 8 \Omega$

figure 43.

IGBT

Typical switching times as a function of IGBT turn on gate resistor  
 $t = f(R_g)$



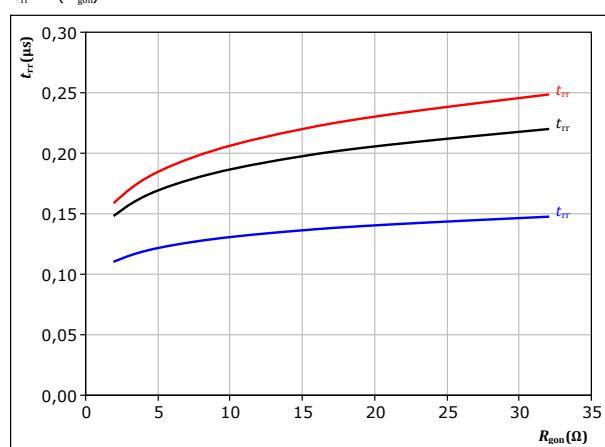
With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 750 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 170 \text{ A}$

figure 45.

FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 750 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 170 \text{ A}$



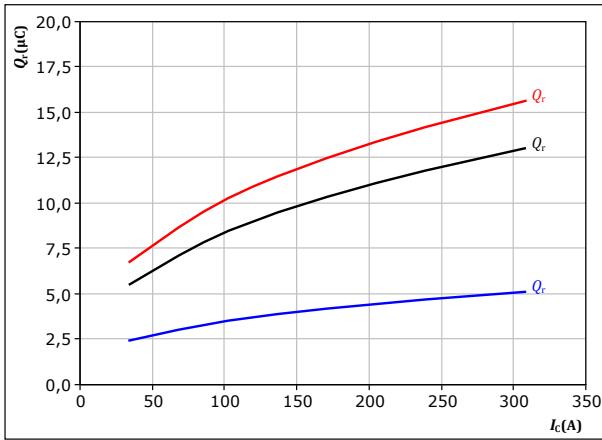
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## DC-Link Switching Characteristics

figure 46.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

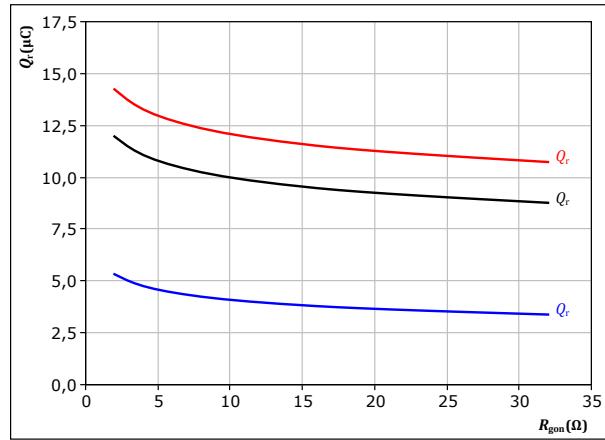
$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 8 \Omega & T_f &= 125 \text{ °C} \\ & & & \text{---} \\ & & & T_f = 150 \text{ °C} \end{aligned}$$

FWD

figure 47.

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

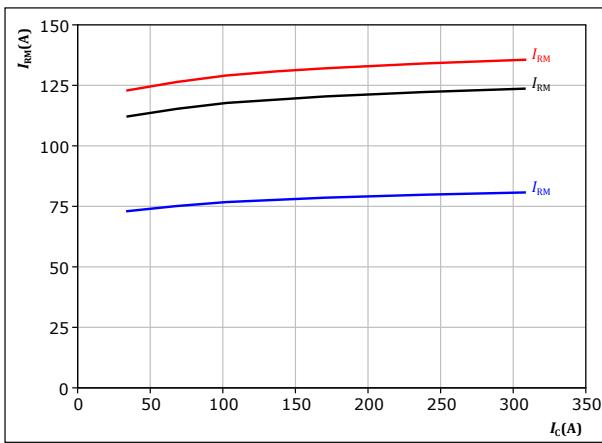
$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 170 \text{ A} & T_f &= 125 \text{ °C} \\ & & & \text{---} \\ & & & T_f = 150 \text{ °C} \end{aligned}$$

FWD

figure 48.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

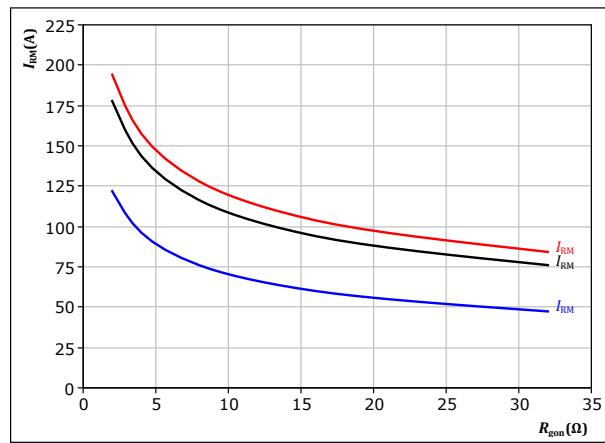
$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 8 \Omega & T_f &= 125 \text{ °C} \\ & & & \text{---} \\ & & & T_f = 150 \text{ °C} \end{aligned}$$

FWD

figure 49.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 750 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 170 \text{ A} & T_f &= 125 \text{ °C} \\ & & & \text{---} \\ & & & T_f = 150 \text{ °C} \end{aligned}$$

FWD

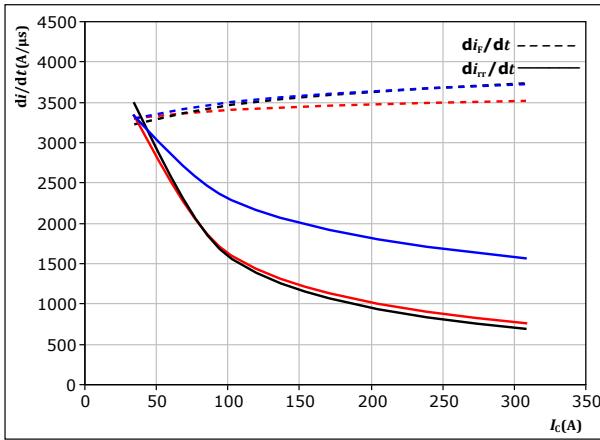


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## DC-Link Switching Characteristics

figure 50. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_c)$

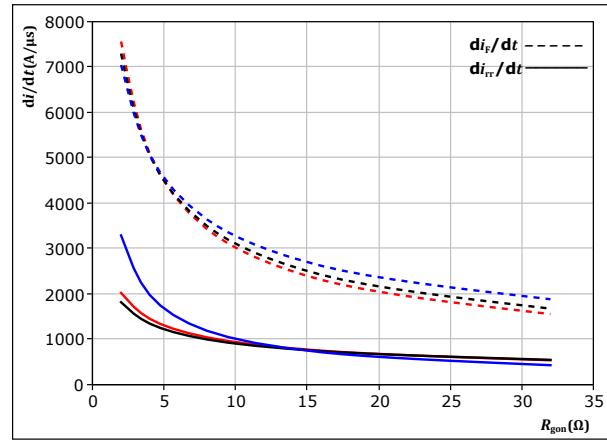


With an inductive load at

$V_{CE} = 750$  V       $T_j = 25$  °C  
 $V_{GE} = \pm 15$  V       $T_j = 125$  °C  
 $R_{gon} = 8$  Ω       $T_j = 150$  °C

figure 51. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



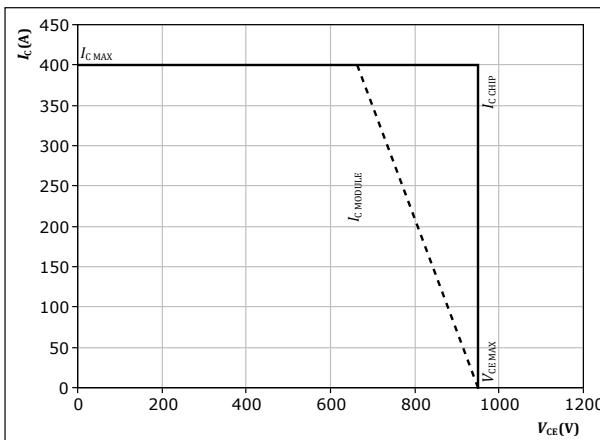
With an inductive load at

$V_{CE} = 750$  V       $T_j = 25$  °C  
 $V_{GE} = \pm 15$  V       $T_j = 125$  °C  
 $I_c = 170$  A       $T_j = 150$  °C

figure 52. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At       $T_j = 150$  °C

$R_{gon} = 8$  Ω  
 $R_{goff} = 8$  Ω

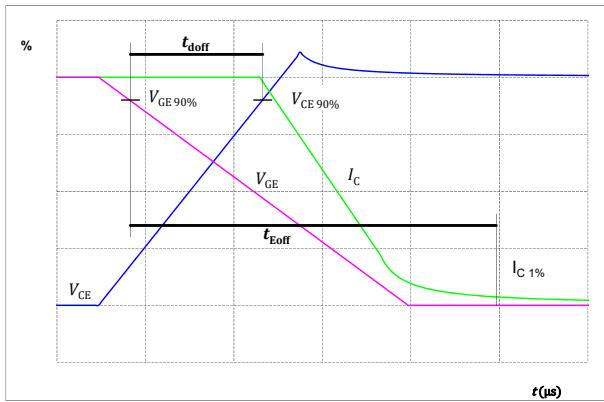


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## Switching Definitions

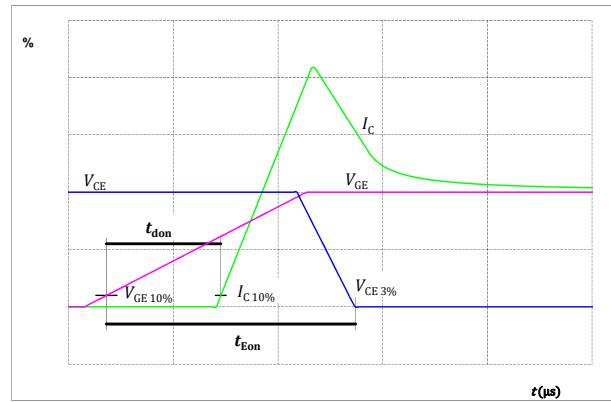
**figure 53.** IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



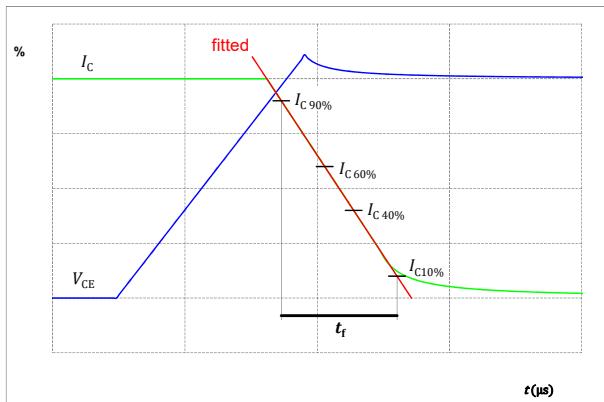
**figure 54.** IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



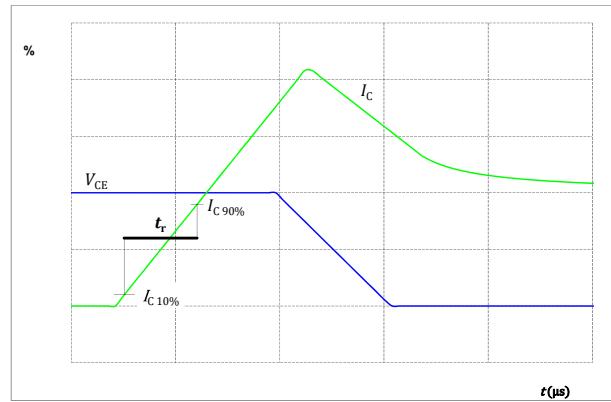
**figure 55.** IGBT

Turn-off Switching Waveforms & definition of  $t_f$



**figure 56.** IGBT

Turn-on Switching Waveforms & definition of  $t_r$





Vincotech

## Switching Definitions

figure 57.

Turn-off Switching Waveforms & definition of  $t_{tr}$

FWD

Turn-off Switching Waveforms & definition of  $t_{tr}$  ( $t_{tr}$  = integrating time for  $I_F$ )

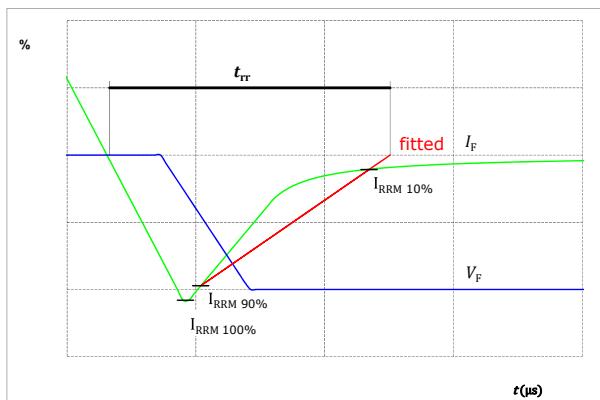
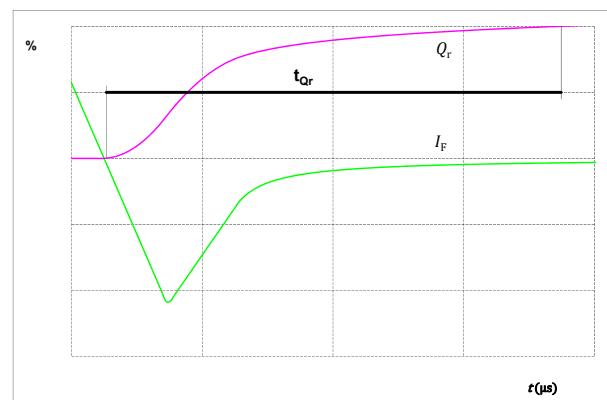


figure 58.

Turn-on Switching Waveforms & definition of  $t_{qr}$  ( $t_{qr}$  = integrating time for  $Q_r$ )

FWD

Turn-on Switching Waveforms & definition of  $t_{qr}$  ( $t_{qr}$  = integrating time for  $Q_r$ )



**30-PT10NAA200S701-PE59F08Y**

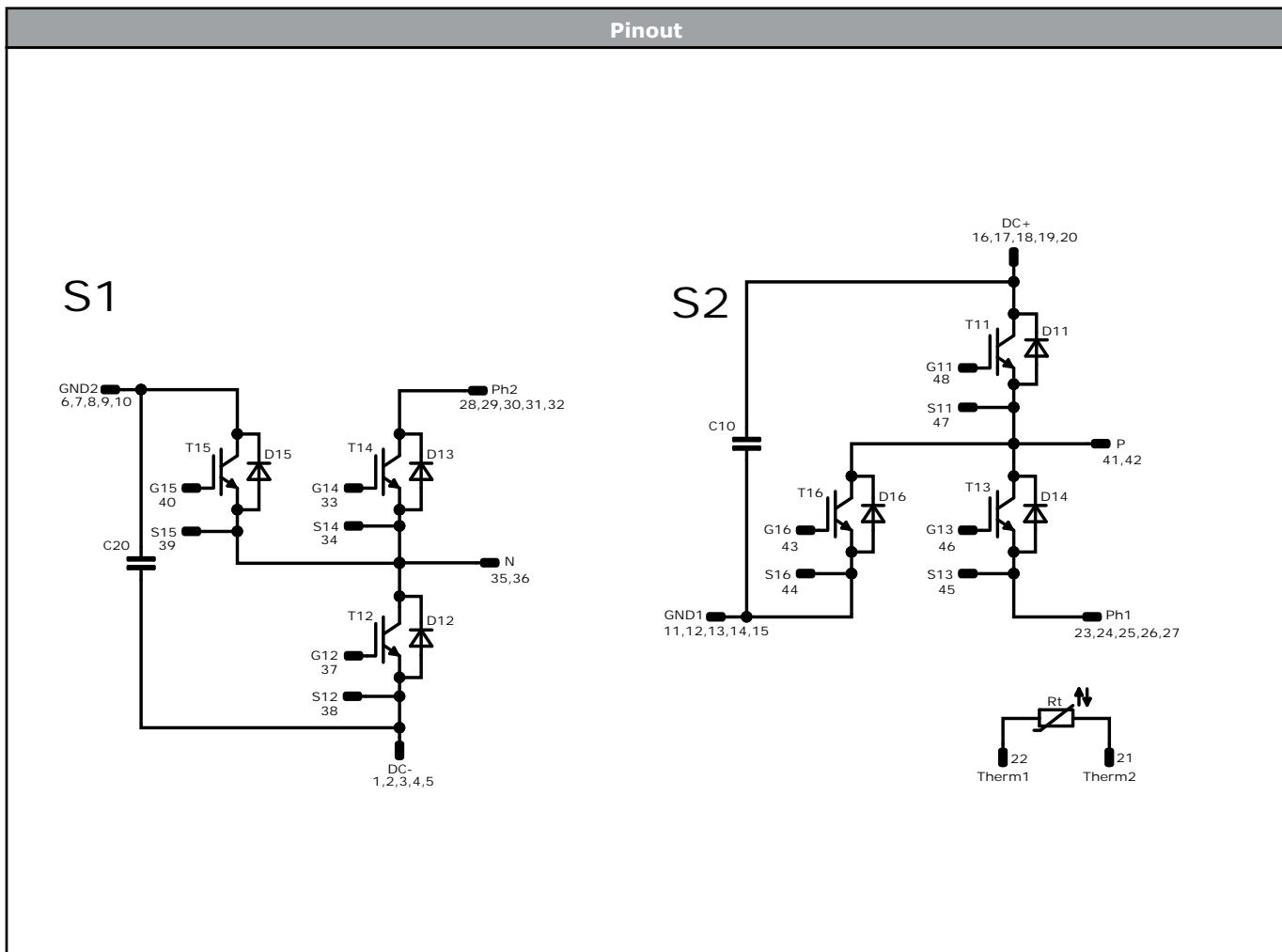
datasheet

**Vincotech**

Ordering Code							
Version				Ordering Code			
Without thermal paste				30-PT10NAA200S701-PE59F08Y			
With thermal paste (3,4 W/mK, PSX-P7)				30-PT10NAA200S701-PE59F08Y-/3/			
Marking							
<small>NNNNNNNNNNNNNN TTTTTTVVWWYY JL VIN LLLL SSSS</small>	<b>Text</b>	Name	Date code	UL & VIN	Lot	Serial	
		NN-NNNNNNNNNNNNNN- TTTTTTVV	WWYY	UL VIN	LLLLL	SSSS	
	<b>Datamatrix</b>	Type&Ver	Lot number	Serial	Date code		
		TTTTTTTVV	LLLLL	SSSS	WWYY		
Outline							
Pin table [mm]							
Pin	X	Y	Function	25	43,4	36,5	Ph1
1	1,5	0	DC-	26	40,7	36,5	Ph1
2	4,2	0	DC-	27	38	36,5	Ph1
3	6,9	0	DC-	28	32,5	36,5	Ph2
4	9,6	0	DC-	29	32,5	33,8	Ph2
5	12,3	0	DC-	30	29,8	36,5	Ph2
6	21,7	0	GND2	31	27,1	36,5	Ph2
7	24,4	0	GND2	32	24,4	36,5	Ph2
8	27,1	0	GND2	33	11,1	26,45	G14
9	29,8	0	GND2	34	11,1	23,45	S14
10	32,5	0	GND2	35	16,25	23,45	N
11	38	0	GND1	36	18,95	23,45	N
12	41,25	0	GND1	37	0	5,55	G12
13	44,5	0	GND1	38	0	2,7	S12
14	47,75	0	GND1	39	20,5	19,2	S15
15	47,75	2,7	GND1	40	23,5	19,2	G15
16	57,15	0	DC+	41	46,75	19,6	P
17	59,85	0	DC+	42	46,75	16,6	P
18	62,55	0	DC+	43	38	5,55	G16
19	65,25	0	DC+	44	38	2,7	S16
20	67,95	0	DC+	45	48,8	33,8	S13
21	70,5	33,5	Therm2	46	48,8	30,8	G13
22	66,45	36,5	Therm1	47	58,5	19,15	S11
23	48,8	36,5	Ph1	48	61,5	19,15	G11
24	46,1	36,5	Ph1				



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**Identification**

ID	Component	Voltage	Current	Function	Comment
T13, T14	IGBT	950 V	200 A	AC Switch	
D13, D14	FWD	950 V	200 A	AC Diode	
T15, T16	IGBT	950 V	200 A	Neutral Point Switch	
D12, D11	FWD	950 V	200 A	DC-Link Diode	
T11, T12	IGBT	950 V	200 A	DC-Link Switch	
D16, D15	FWD	950 V	200 A	Neutral Point Diode	
C10, C20	Capacitor	1000 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	

**30-PT10NAA200S701-PE59F08Y**

datasheet

**Vincotech****Packaging instruction**

Standard packaging quantity (SPQ) 36	>SPQ	Standard	<SPQ	Sample
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**Handling instruction**

Handling instructions for flow 2 packages see vincotech.com website.

**Package data**

Package data for flow 2 packages see vincotech.com website.

**Vincotech thermistor reference**

See Vincotech thermistor reference table at vincotech.com website.

**UL recognition and file number**

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
30-PT10NAA200S701-PE59F08Y-D1-14	23 Aug. 2022		

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